

## Statement of Compliance

## **Requested Part**

TE Internal Number1658623.4Product Description20 NOVO MIL 30DP, LEAD FREEPart StatusActiveMil-Spec CertifielNoBU ROHS Directive 2011/65/EUCompliantThis declaration covers EU Directive 2011/65/EU Incl DirectiveCompliant2000/53/ECOmpliantLing RoHS 2 Directive 2000/53/ECOmpliantChina RoHS 2 Directive 2000/53/ECOmpliantBU REACH Regulation (EC) No. 1907/2000Current ECHA Candidate List: JAN 2023 (233) Directive Taxina REACH Schere Directive Schere Against: JAN 2023 (233) Direction contain REACH SchereHalogen ContertNot Low Halogen - contains Br or C > 900 ppm.Not Low Halogen - contains Br or C > 900 ppm.Not applicable for solder process capability ContainMaterial DeclarationMotaplicable for solder process capabilityMaterial DeclarationMotaplicable for solder process capability	11 June 2023	1658623-4		(Part 1 of 1)	
Part Status:ActiveMil-Spec Certifiet:NoEU RoHS Directive 2011/65/EU:CompliantThis declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2000/53/ECCompliant2000/53/ECCompliant2000/53/ECImage: China RoHS 2 Directive:MilT Order No 32, 2016Image: China RoHS 2 Directive:EU REACH Regulation:Current ECHA Candidate List: JAN 2023 (233)(EC) No. 1907/2006Current ECHA Candidate List: JAN 2023 (233)Does not contain REACH SVHCDirective:Halogen Contem:Not Low Halogen - contains Br or Cl > 900 ppm.Solder Process Capability CodeNot applicable for solder process capability		TE Internal Number:	1658623-4		
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EU RoHS Directive 2011/65/EU:       Compliant         This declaration covers EU Directive 2011/65/EU incl. Delegated Directive:       Compliant         2000/53/EC       Compliant         2000/53/EC       Compliant         MIIT Order No 32, 2010       Image: Compliant         EU REACH Regulation       Current ECHA Candidate List: JAN 2023 (233)         Chioa RoHS 2, 1007/2006       Current ECHA Candidate List: JAN 2023 (233)         Does not contain REACH SVHC       Does not contain REACH SVHC         Halogen Content       Not Low Halogen - contains Br or Cl > 900 ppm.		Part Status:	Active		
This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.       EU ELV Directive:       Compliant         2000/53/EC       2000/53/EC       China RoHS 2 Directive:       Compliant         MIIT Order No 32, 2016       Image: Current ECHA Candidate List: JAN 2023 (233)       Candidate List Declared Against: JAN 2023 (233)         CEC No. 1907/2006       Current ECHA Candidate List: JAN 2023 (233)       Candidate List Declared Against: JAN 2023 (233)         Does not contain REACH SVHC       Not Low Halogen - contains Br or CI > 900 ppm.         Solder Process Capability Code:       Not applicable for solder process capability		Mil-Spec Certified:	No		
EU ELV Directive: 2000/53/ECCompliant2000/53/ECChina RoHS 2 Directive: MIIT Order No 32, 2016Image: China RoHS 2 Directive: Image: China RoHS 2, 2016EU REACH Regulation: (EC) No. 1907/2006Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHCHalogen Content:Not Low Halogen - contains Br or Cl > 900 ppm.Solder Process Capability Code:Not applicable for solder process capability	EU R	oHS Directive 2011/65/EU:	Compliant		
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<ul> <li>(EC) No. 1907/2006 Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC</li> <li>Halogen Content: Not Low Halogen - contains Br or Cl &gt; 900 ppm.</li> <li>Solder Process Capability Code: Not applicable for solder process capability</li> </ul>			No Restricted Materials Above	Threshold	
Solder Process Capability Code: Not applicable for solder process capability		•	Candidate List Declared Against: JAN 2023 (233)		
		Halogen Content:	Not Low Halogen - contains Br or Cl	> 900 ppm.	
Material Declarations: MD_1658623-4	Solde	r Process Capability Code:	Not applicable for solder process ca	pability	
		Material Declarations:	MD_1658623-4		

**TE Connectivity Corporation** 

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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